N-Channel Enhancement Mode Power MOSFET

Description

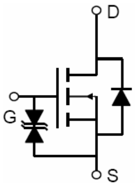
This Product uses advanced trench technology MOSFETs to provide excellent $R_{DS(ON)}$ and low gate charge. The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

General Features

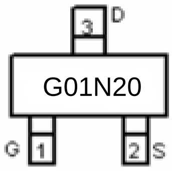
- V_{DS} 200V
- I_D (at V_{GS} = 10V) 1.7A
- $R_{DS(ON)}$ (at V_{GS} = 10V) < 0.85Ω
- $R_{DS(ON)}$ (at V_{GS} = 4.5V) < 0.9Ω
- 100% Avalanche Tested
- RoHS Compliant
- ESD (HBM)>5.0KV

Application

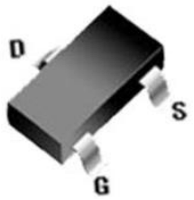
- Power switch
- DC/DC converters



Schematic diagram



Marking and pin assignment



SOT-23-3L

Device	Package	Marking	Packaging
G01N20LE	SOT-23-3L	G01N20	3000pcs/Reel

Absolute Maximum Ratings T_C = 25ºC, unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	200	V
Continuous Drain Current	I_D	1.7	A
Pulsed Drain Current (note1)	I_{DM}	6.8	A
Gate-Source Voltage	V_{GS}	±20	V
Power Dissipation	P_D	1.5	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 To 150	ºC

Thermal Resistance

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	R_{thJA}	83	ºC/W

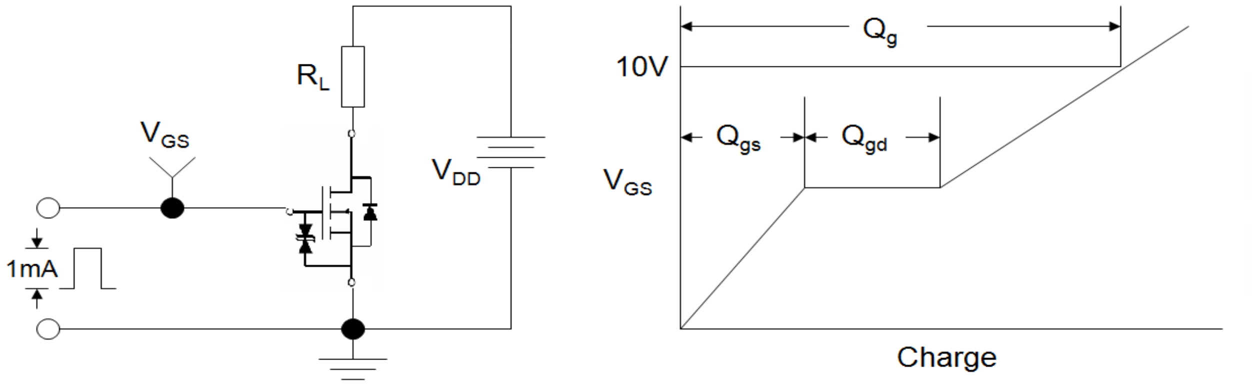
Specifications T_J = 25ºC, unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static Parameters						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250µA	200	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 200V, V_{GS} = 0V	--	--	1	uA
Gate-Source Leakage	I_{GSS}	V_{GS} = ±20V	--	--	±30	uA
Gate-Source Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250µA	1	1.8	2.5	V
Drain-Source On-Resistance	$R_{DS(on)}$	V_{GS} = 10V, I_D = 1.7A	--	0.56	0.85	Ω
		V_{GS} = 4.5V, I_D = 1.7A	--	0.58	0.9	
Forward Transconductance	g_{FS}	V_{DS}=15V,I_D=1.7A	--	8	--	S
Dynamic Parameters						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = 25V, f = 1.0MHz	--	580	--	pF
Output Capacitance	C_{oss}		--	90	--	
Reverse Transfer Capacitance	C_{rss}		--	30	--	
Total Gate Charge	Q_g	V_{DD} = 100V, I_D = 1.7A, V_{GS} = 10V	--	12	--	nC
Gate-Source Charge	Q_{gs}		--	2.5	--	
Gate-Drain Charge	Q_{gd}		--	3.8	--	
Turn-on Delay Time	$t_{d(on)}$	V_{DD} = 100V, I_D = 1.7A, R_G = 2.5Ω	--	10	--	ns
Turn-on Rise Time	t_r		--	12	--	
Turn-off Delay Time	$t_{d(off)}$		--	15	--	
Turn-off Fall Time	t_f		--	15	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I_S	T_C = 25ºC	--	--	1.7	A
Body Diode Voltage	V_{SD}	T_J = 25ºC, I_{SD} = 1.7A, V_{GS} = 0V	--	--	1.2	V

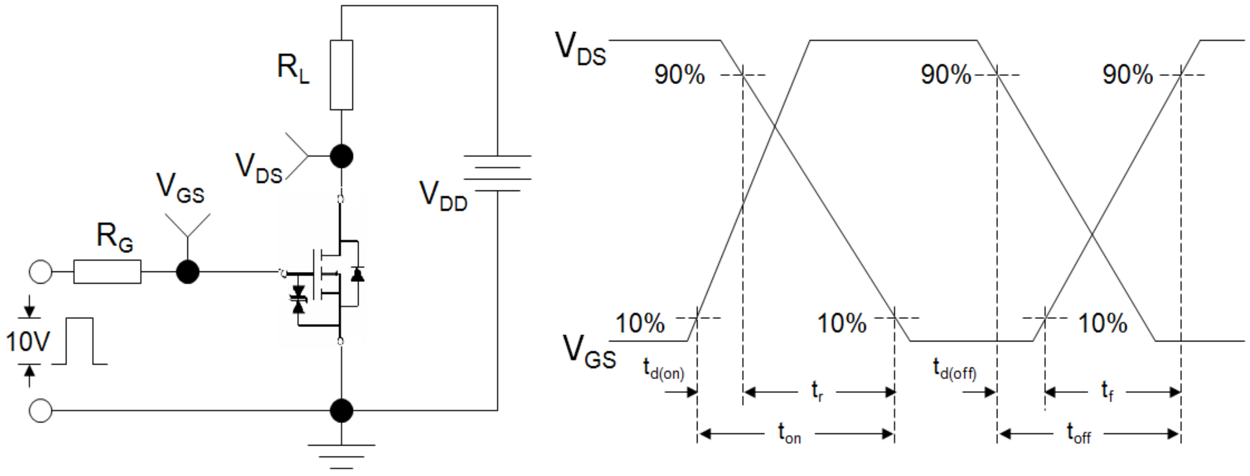
Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Identical low side and high side switch with identical R_G

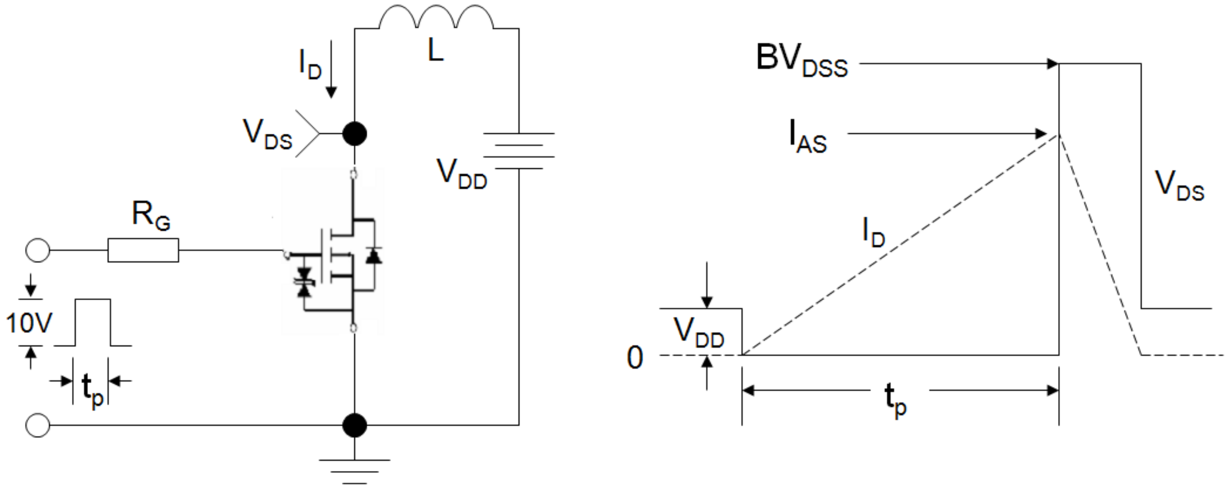
Gate Charge Test Circuit



Switch Time Test Circuit



EAS Test Circuit



Typical Characteristics T_J = 25ºC, unless otherwise noted

Figure 1. Output Characteristics

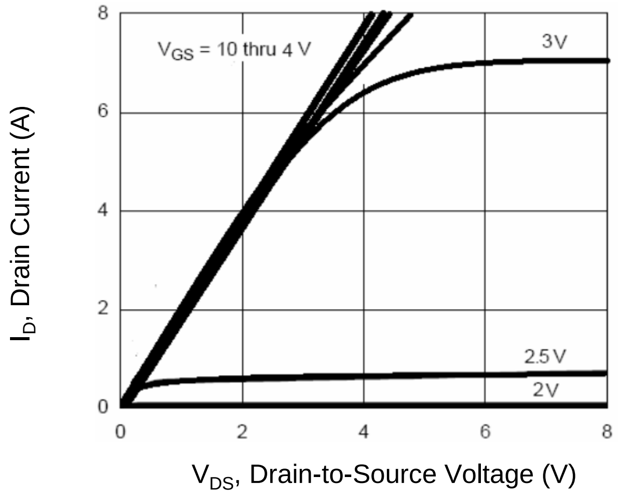


Figure 2. Transfer Characteristics

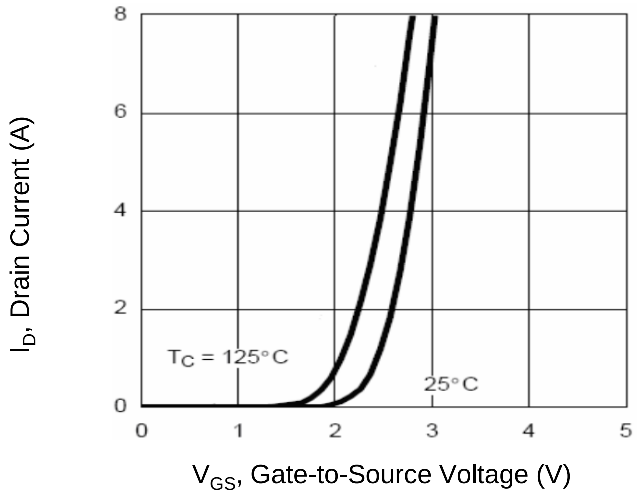


Figure 3.Drain Source On Resistance

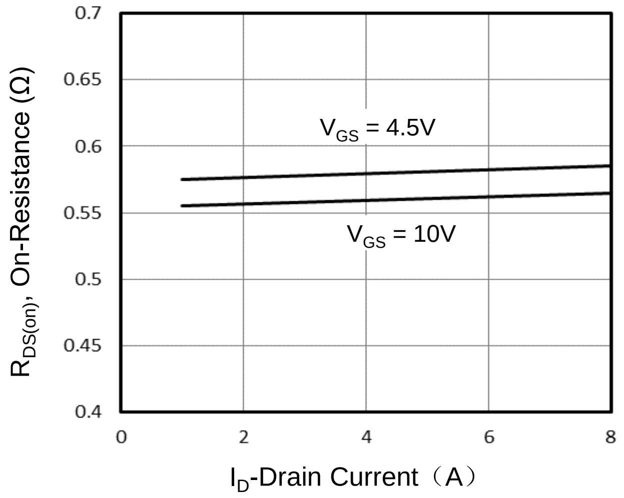


Figure 4. Gate Charge

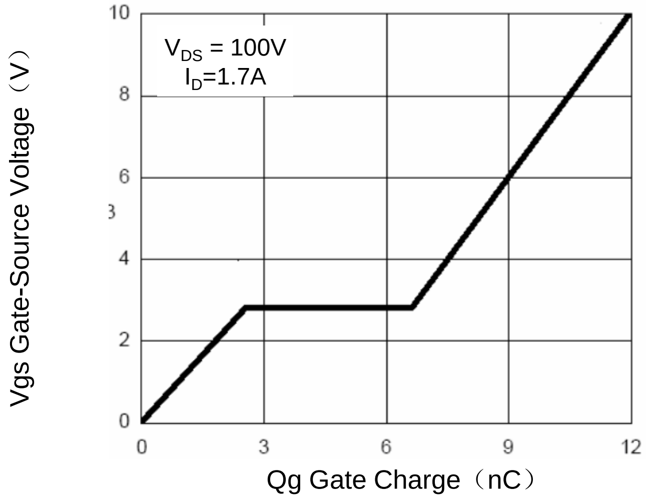


Figure 5. Capacitance vs Vds

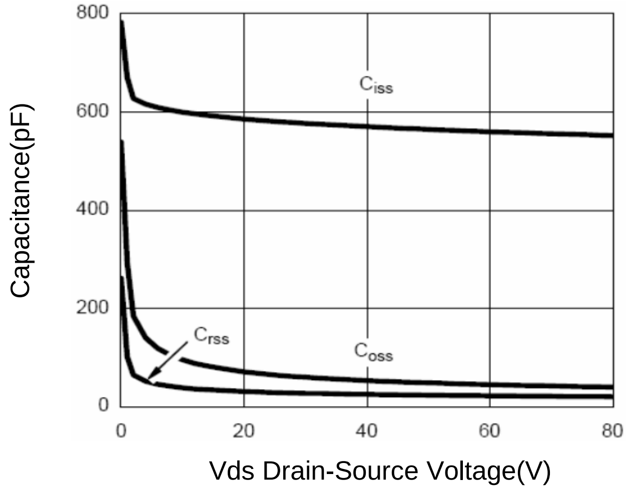
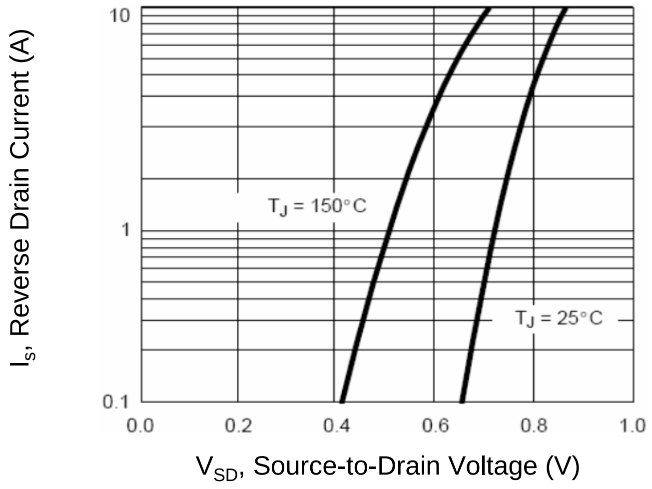


Figure 6. Source-Drain Diode Forward



Typical Characteristics T_J = 25ºC, unless otherwise noted

Figure 7. Drain-Source On-Resistance

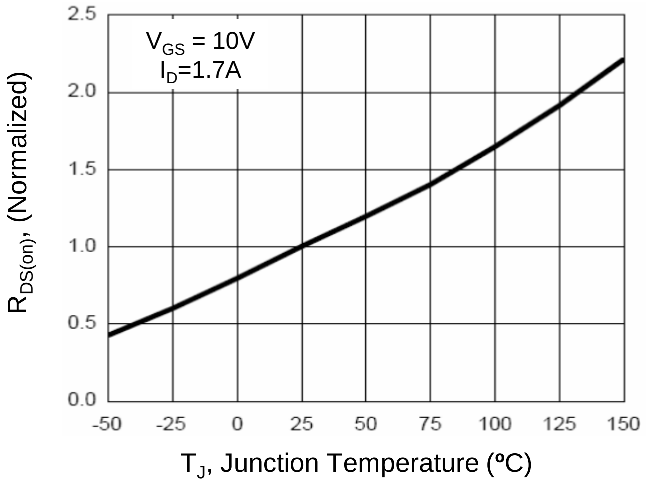


Figure 8. Safe Operation Area

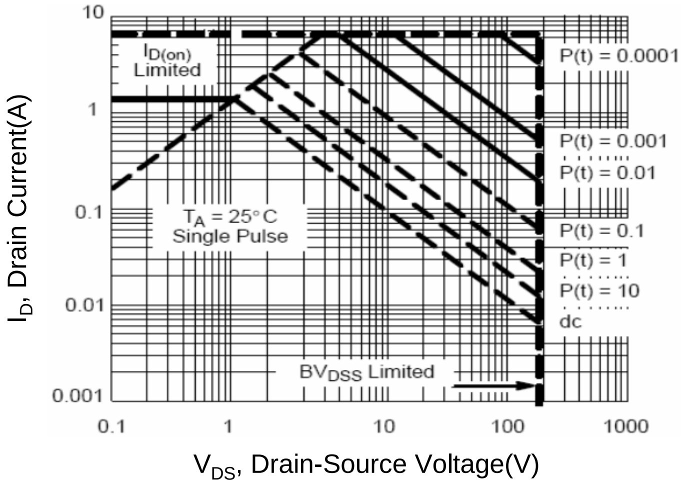
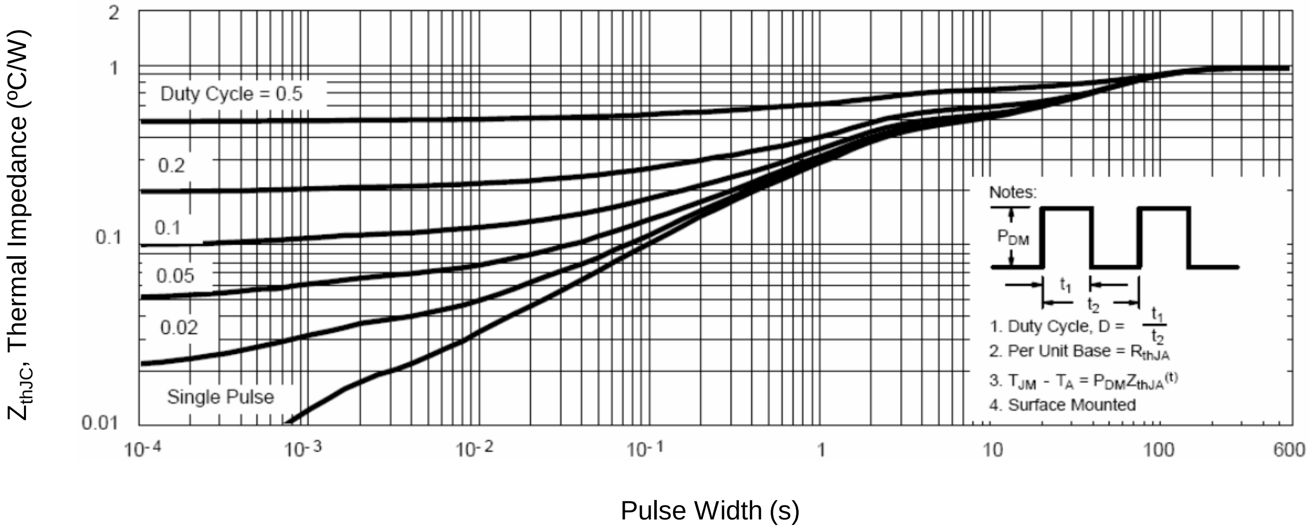
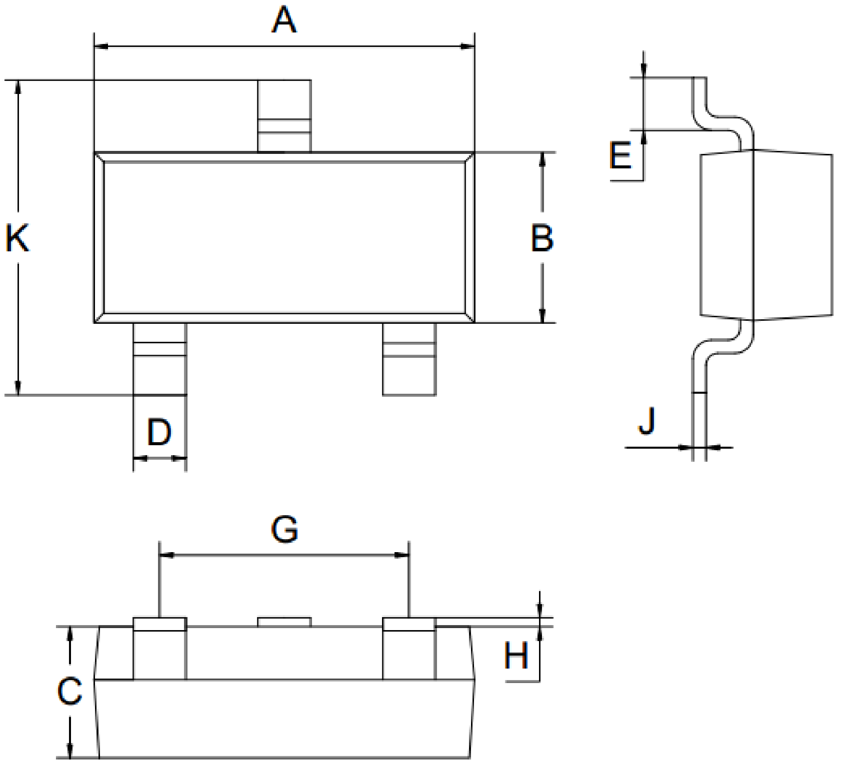


Figure 9. Normalized Maximum Transient Thermal Impedance



SOT-23-3L Package Information



Symbol	Dimensions in Millimeters		
	MIN.	**NOM.**	**MAX.**
A	2.80	2.90	3.00
B	1.50	1.60	1.70
C	1.00	1.10	1.20
D	0.30	0.40	0.50
E	0.25	0.40	0.55
G	1.90		
H	0.00	-	0.10
J	0.047	0.127	0.207
K	2.60	2.80	3.00
All Dimensions in mm			